Relation between the PCB Near Field and the Common Mode Coupling from the PCB to Cables

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Abstract—The common mode coupling from PCB sources to cables is one of the most significant emission mechanisms. We obtain a design expression for the common mode coupling inductance of a PCB trace inside a cavity from the cavity field, which is excited by this trace. This reveals a general relation between the coupling of PCB sources to a cavity and the common mode coupling to cables. In a second step we show that the coupling of a PCB to a parallel plane cavity can be obtained from the PCB near field.

I. INTRODUCTION

The magnetic flux lines wrapping around the ground plane of a PCB cause a voltage between wires which are connected at the PCB [1]. Fig. 1 shows the magnetic flux and the associated common mode voltage $U_{cm}$, which drives a current on the cables, connected to the PCB. This current causes common mode emission from the cables. Near field scanning over a PCB is a state of the art method to investigate the EMC performance of PCBs experimentally [2], [3]. Usually the magnetic field vector components $|H_x|$, $|H_y|$ and $H_{mag} = \sqrt{|H_x|^2 + |H_y|^2}$ are scanned versus frequency as depicted in Fig. 2. Increased field value areas on the PCB are observed as potential electromagnetic emission sources. However, an explicit relation between the scanned near field and the common mode voltage $U_{cm}$ is missing. Since the common mode coupling of a PCB trace to cables depends on the trace geometry and the trace position on the PCB and not only on the trace current magnitude, critical areas on the PCB cannot generally be assigned to areas with increased near field magnitudes. In Section II we obtain the common mode inductance $L_{cm}$ for a PCB trace inside a parallel plane cavity from the cavity model of [4]. We verify this $L_{cm}$ with measurements and a comparison with the common mode inductance formulation for parallel planes of [5]. This provides the relation between the coupling of PCB traces to the cavity and the common mode inductance of these traces. In Section III we describe a method to obtain the PCB coupling to a cavity from the magnetic near field above the PCB. Thus, we achieve a quantitative relationship between the PCB near field and the common mode coupling from sources on the PCB to cables.

II. DERIVATION OF THE COMMON MODE INDUCTANCE OF A PCB TRACE INSIDE A CAVITY

The differential mode current on the trace $I_{dm}$ and common mode inductance $L_{cm}$ in Fig. 1 determine the common mode voltage

$$U_{cm} = j\omega L_{cm} I_{dm}. \quad (1)$$

For a trace in the symmetry line (x=L/2) of the ground plane (Trace a in Fig. 3) the common mode inductance is

$$L_{cm} = \frac{4\mu dl_x}{\pi^2 L} \quad (2)$$

according to [5]. The trace length is $l_x$. 

![Fig. 1. Model illustrating the physics of the current driven common mode mechanism as described in [1].](image1)

![Fig. 2. Scanning the magnetic field above the PCB with a magnetic field probe.](image2)
The trace inductance for a trace located at a distance $s$ from the ground plane symmetry line (Trace $b$ in Figure 3) is

$$L_{cm} = \frac{\mu l_t}{2\pi} \ln \left| \frac{s + jd}{L} + \sqrt{4 \left( \frac{s + jd}{L} \right)^2 - 1} \right|$$

(3)

according to [6]. A trace in the symmetry line of the ground plane ($s=0$) [6] reduces (3) to

$$L_{cm} = \frac{\mu l_t}{\pi L}$$

(4)

The equations (2) and (4) have been obtained for a narrow trace ($w_t \ll L$) above the PCB ground plane and without a metallic cover plane. For a parallel plane structure ($w_t = L$, trace width = ground plane width) the common mode inductance is

$$L_{cm,pm} = \frac{h\mu l_t}{2L}$$

(5)

according to [5], where $h$ is the plane separation distance.

A $\mu$-TEM cell measurement with a hybrid coupler was carried out by [7] to obtain the coupling from heat sinks to cables and by [8] to obtain the magnetic moment for the coupling of a trace to cables. This measurement configuration is shown in Fig. 4. The coordinate system definition is consistent with those in Fig. 1 and Fig. 3. The magnetic field coupling moment

is obtained from the $A-B$ output of the hybrid coupler by [8]. To obtain the magnetic coupling of a trace to the cavity between two parallel rectangular planes, the model depicted in Fig. 5 is utilized. The voltages

$$U_i(x_i, y_i) = \sum_{j=1}^{n_{port}} (Z_{ij}(x_i, y_i, x_j, y_j)) I_j(x_j, y_j)$$

(6)

on ports, defined between the cover and the bottom plane of the rectangular cavity, are related to the port currents $I_j(x_j, y_j)$ by the impedance matrix. The coordinates of Port $i$ and Port $j$ are $(x_i, y_i)$ and $(x_j, y_j)$ respectively. Indexes $i$ and $j$ run from $1 \ldots n_{port}$, where $n_{port}$ the number of ports. According to [9], the impedance matrix elements are

$$Z_{ij} = \frac{j\omega l_t}{LW} \sum_{m=0}^{\infty} \sum_{n=0}^{\infty} \frac{L_m L_n N_i N_j}{k_m^2 + k_n^2 - (2\pi/\lambda)^2},$$

(7)

with

$$N_i = \cos(k_m x_i) \cos(k_n y_i) \frac{\sin\left(\frac{k_m w_{xi}}{2}\right)}{\sin\left(\frac{k_n w_{yi}}{2}\right)},$$

(8)

$$N_j = \cos(k_m x_j) \cos(k_n y_j) \frac{\sin\left(\frac{k_m w_{xj}}{2}\right)}{\sin\left(\frac{k_n w_{yj}}{2}\right)},$$

(9)

$$k_m = \frac{m\pi}{L_w}, \quad k_n = \frac{n\pi}{W_c},$$

(10)

and

$$\sin(x) = \frac{\sin(x)}{x}.$$  

(11)

$L_m$ are one for $m = 0$ and two for nonzero $m$. $L_n$ are one for $n = 0$ and two for nonzero $n$. The port dimensions for the rectangular ports $i$ and $j$ are $(w_{xi}, w_{yi})$ and $(w_{xj}, w_{yj})$ respectively and $\lambda$ is the wavelength. The coupling from a trace, like in Fig. 5, to the cavity field is considered with two ports in (6) according to [4]. One port at the source position $so$ of the trace and a second port at the load position $lo$ of the trace. For the introduction of the trace to (6), the trace currents have to be weighted by the trace to cavity coupling factor $d/h$. Since we need only mutual impedances to express the coupling from the trace to the cavity ports $A$ and $B$ in Fig. 5, we neglect the $\sin()$ terms in (8) and (9). With the ports and the trace in Fig. 5 the voltage difference of Port $A$ and Port $B$ becomes

$$U_{AB} = -\frac{j\omega l_t}{LW} \frac{\sin(x)}{x} \sum_{m=0}^{\infty} \sum_{n=0}^{\infty} L_m L_n \frac{N_i}{N_j} \frac{1 - (-1)^n}{2} \cos^2\left(\frac{m\pi}{L_w}\right) \frac{(\frac{m\pi}{L_w})^2 + (\frac{n\pi}{W_c})^2 - (\frac{\pi}{\lambda})^2}{2}.$$  

(12)
with

\[ K_t = \cos \left( \frac{n\pi}{W} \left( \frac{W}{2} + \frac{l_t}{2} \right) \right) - \cos \left( \frac{n\pi}{W} \left( \frac{W}{2} - \frac{l_t}{2} \right) \right) \]  

(13)

According to the factor \((1 - (-1)^n)\) terms with even \(n\) vanish. The nominator term \((2\pi/\lambda)\) may be neglected for low frequencies \(W \ll \lambda\). With this simplification, (12) becomes

\[ U_{AB} = j\omega M_c I = \frac{4j\omega \mu dl}{W} \sum_{m=0}^{\infty} \sum_{n=0}^{\infty} L_m \sin \left( \frac{n\pi}{2W} \right) \sin \left( \frac{(2m+1)\pi l_t}{W} \right) \left( \frac{2m\pi}{L} \right)^2 + \left( \frac{n\pi}{W} \right)^2 \]

\[ = \frac{8j\omega \mu dl}{LW} \sum_{m=0}^{\infty} \sum_{n=0}^{\infty} L_m (-1)^n \sin \left( \frac{(2n+1)\pi l_t}{2W} \right) \left( \frac{2m\pi}{L} \right)^2 + \left( \frac{(2n+1)\pi}{W} \right)^2 \]  

(14)

The coupling inductance of the trace inside the cavity is

\[ M_c = \frac{8\mu dl}{LW} \sum_{n=0}^{\infty} \left\{ \frac{1}{2} \pi \sin \left( \frac{(2n+1)\pi l_t}{2W} \right) \right\} \left[ \frac{2m\pi}{L} \right]^2 + \left( \frac{(2n+1)\pi}{W} \right)^2 \]  

(15)

With

\[ \sum_{m=1}^{\infty} \frac{1}{a^2 + m^2} = \frac{\pi}{2} \coth \left( \pi \frac{a}{2} \right) - \frac{1}{a^2}, \]  

(16)

(15) is simplified to

\[ M_c = \frac{8\mu dl}{LW} \sum_{n=0}^{\infty} \left\{ \frac{1}{2} \pi \sin \left( \frac{(2n+1)\pi l_t}{2W} \right) \right\} \frac{\coth \left( \frac{(2n+1)\pi L}{2W} \right)}{2n+1} \]  

(17)

For small traces \(l_t \ll W\) the function described by the fourier series in (17) is approximated by the first term of its Taylor series, developed around \(l_t = 0\) and (17) becomes

\[ M_c = \frac{2\mu dl_t}{W} \sum_{n=0}^{\infty} \left\{ (-1)^n \coth \left( \frac{(2n+1)\pi L}{2W} \right) \right\} \]  

(18)

With

\[ \sum_{n=0}^{\infty} \left\{ (-1)^n \coth \left( \frac{(2n+1)\pi L}{2W} \right) \right\} \approx \frac{\pi}{4} \coth \left( \frac{L\pi}{2W} \right) \]  

(19)

and

\[ \coth(x) \approx \frac{1}{x} \quad \forall \quad |x| < 1, \]  

(20)

the coupling inductance for \(L < (2/\pi)W \approx 0.6W\) becomes

\[ M_c = \frac{\mu dl_t}{L} \]  

(21)

The common mode inductance is associated with the flux wrapping around only one of the two planes. Thus, the coupling inductance has to be divided by a factor of two to obtain the common mode inductance [5]. Therefore, the common mode inductance of a trace inside a parallel plane cavity is

\[ L_{cm,p} = \frac{\mu dl_t}{2L} \]  

(22)

Note that (22) becomes exactly (5) of [5], when the trace height above the ground plane is identical to the plane separation distance \(h\). Equation (5) has been verified experimentally by [5]. We have carried out VNA (vector network analyzer) measurements with the setup in Fig. 6 to verify (22). The dimensions of the test setup are \(W = 120\text{mm}, L = 50\text{mm}, l_t = 10\text{mm}, d = 1\text{mm}, h = 10\text{mm}, w_t = 2\text{mm}, \) and \(l_l = 500\text{mm}\). One measurement is carried out with a cover plane and a second measurement without the cover plane.

![Fig. 6. Measurement of the common mode inductance. A trace loop above a copper plane is connected to one port of the VNA. The trace is terminated with 0 Ohm to the ground copper plane. A wire loop is soldered to both ends of the copper plane and a SMA connector in this loop is connected to the second VNA port for the measurement of the induced common mode loop voltage.](image)

Fig. 7 shows good agreement of the measured common mode inductances to the analytical results from (4) of 0.08nH for the configuration without a cover plane and to the result from (22) of 0.12nH for the configuration with a cover plane. This provides evidence that the current driven common mode coupling mechanism of a trace inside a parallel-plane cavity to cables is described sufficiently with the cavity model. The cavity model describes not only the common mode mechanism for a tiny trace in the symmetry line of the cavity, but also the common mode coupling for arbitrary traces inside the cavity.

![Fig. 7. Measured results for the common mode inductance of a trace above a ground plane, with and without a metallic cover above the trace.](image)
III. RELATION OF THE PCB NEAR FIELD TO THE CAVITY FIELD

In Section II we described the relation between the cavity field and common mode coupling to cables. Only the vertical current segments of a trace couple to the cavity, according to [4]. High currents on PCB traces and ICs are identified from a near field magnitude scan. The vertical currents in the scan plane

\[ I_{s_i} = \int_{A_i} J_x \, dA = \int_{A_i} \left( \frac{\partial}{\partial x} H_y - \frac{\partial}{\partial y} H_x \right) \, dA, \]  

(23)

are obtained from the measured magnetic near field values \( H_x \) and \( H_y \). \( J_x \) is the vertical current density and \( A_i \) denotes the area of the scan plane assigned to the vertical current with the index \( i \). Fig. 8 depicts the described procedure of obtaining the vertical currents from the measured near field above a trace.

Magnetic field magnitude

\[
\text{Trace} \quad I_{s_i} \quad \text{Vertical currents} \quad I_{s_i} = \int_{A_i} J_x \, dA
\]

Fig. 8. Example of obtaining the vertical currents of a trace from the magnetic near field.

In Section II we obtained the cavity field from the vertical trace currents \( I_i \) weighted with \( d/h \). According to

\[ I_i = I_{s_i} \frac{d_s}{d} \Rightarrow I_i \frac{d}{h} = I_{s_i} \frac{d_s}{h}, \]

(24)

where \( d_s \) denotes the height of the scanning plane above the parallel ground plane, the currents \( I_{s_i} \) from (23) with the weighting factor

\[ K_{\text{couple}} = d_s/h, \]

(25)

excite the same cavity field. Thus, the cavity field and the common mode coupling to cables are obtained from a scan measurement, without knowledge of \( d \) and \( I_i \). Equation (23) reveals that not the field density values, but their derivatives are significant for the coupling to the cavity. The cavity field can be obtained from the scanned field up to high cavity modes, when the field scan provides magnitude and phase information. Phase information can either be obtained with a double probe time domain scanner [10], or by the method of [11], which obtains the phase from two magnitude scans with different scan heights above the PCB. For electrically short traces with \( t_i \leq 10 \lambda \), the phase relation between the vertical trace currents is nearly \( 180^\circ \) and thus, the vertical currents can be obtained from introducing only the magnitudes of the scanned magnetic fields to (23). For this purpose, current flow lines and their associated vertical current positions are identified from the near field magnitude plot. Thus, electrically short traces or ICs can be classified regarding their common mode coupling from magnetic field magnitude scans. IC EMC testing according to IEC61967 requires a costly test board and the coupling from the test board to the septum cannot be distinguished from the IC coupling. The proposed method avoids these disadvantages.

IV. CONCLUSIONS

The common mode coupling to cables of a PCB inside a parallel plane cavity can be obtained from the field which is coupled from the PCB to the cavity. This cavity field can be obtained from the near field above the PCB. For electrically short PCB traces and for ICs, the common mode coupling can be obtained just from a magnetic near field magnitude information. The design expression (22) for the common mode inductance provides an efficient first order information about the common mode coupling of PCB traces inside a cavity.

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REFERENCES


